

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of Foster et al)	Examiner:
)	
Serial No. To be assigned)	Art Unit:
)	
Filed: Herewith)	
)	
For: METHODS OF FABRICATING)	
CIRCUITIZED STRUCTURES)	

Docket No. END919970054US2 (IEN-10-5228-D1)

INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

This Information Disclosure Statement is being filed to fulfill the duty of candor and good faith toward the Patent and Trademark Office, as required pursuant to 37 C.F.R. § 1.56.

Listed on the attached PTO form 1449 is information known to persons substantively involved in the preparation of the application identified above, and that a reasonable Examiner would consider important when deciding whether to allow the application. This document is not to be construed as a representation that a search to locate the most relevant information has been made, nor a representation that more pertinent information does not exist.

Copies of the information listed on the attached PTO Form 1449 are provided herewith.

END919970054US2 (IEN-10-5228-D1)

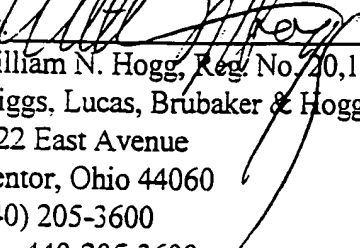
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The identification of any information herein is not intended to be, and should not be understood as being, an admission that such information, in fact, constitutes "prior art" within the meaning of applicable law. The "prior art" status of any information is a matter to be resolved during prosecution.

This Information Disclosure Statement is being filed the application. Accordingly, it is not believed that any fee is required relating to the filing of this Information Disclosure Statement. If this is not the case, the Patent Office is hereby authorized to charge any related fee to Deposit Account No. 09-0457.

Respectfully submitted,

Date: 3-14-01

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Enclosures

APPLICANT'S INFORMATION
DISCLOSURE STATEMENT

Atty. Docket No.: END919970054US2 (IEN-10-5228-D1)

Serial No.: To be assigned

Applicant: Foster et al

Filing Date: Herewith

Group:

U.S. PATENT DOCUMENTS

Initial*		Document No.	Date	Name	Class	Subcl.	Filing Date
	AA	3,469,982	09/30/69	Celeste	96	35.1	09/11/68
	AB	3,794,576	02/26/74	Watt	204	159.11	05/18/71
	AC	4,075,051	02/21/78	Brzozowski	156	236	11/29/76
	AD	4,193,799	03/18/80	Crivello	430	319	05/19/78
	AE	4,451,550	05/29/84	Bennett et al	430	176	07/29/82
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	AG	4,624,912	11/25/86	Zweifel et al	430	258	02/06/85
	AH	4,994,346	02/19/91	Meier et al	430	280	07/20/88
	AI	5,079,129	01/07/92	Roth et al	430	280	11/30/89
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	AP	
	AQ	
	AR	
	AS	
	AT	

Examiner:

Date Considered:

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609: draw line through citation if in conformance and not considered.
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